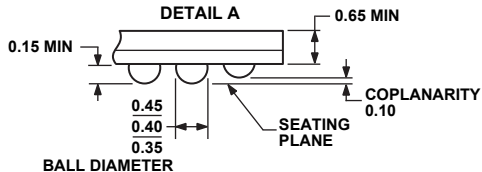
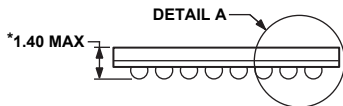
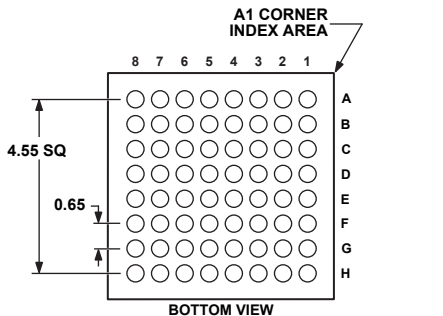
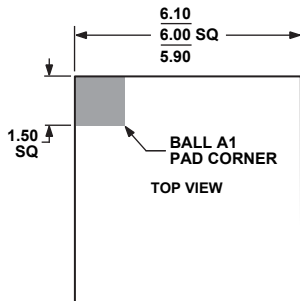


64-Ball Chip Scale Package Ball Grid Array [CSP_BGA]

(BC-64-4)

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-225
WITH THE EXCEPTION TO PACKAGE HEIGHT.